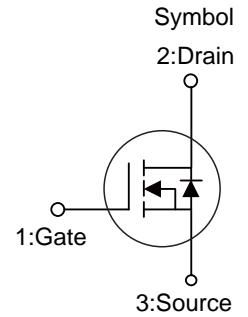


■ PRODUCT CHARACTERISTICS

V <sub>DSS</sub>	750V
R <sub>DS(ON)</sub> Typ(@V <sub>GS</sub> =18V)	150mΩ
Qg@typ	12.5nC
I <sub>D</sub>	15.5A



■ APPLICATIONS

- \*Switch Mode Power Supplies
- \*High Voltage DC/DC Converters
- \*Battery Chargers
- \*Motor Drivers

■ FEATURE

- \*Low On-Resistance With High Blocking Voltage
- \*Low Capacitances With High -Speed Switching
- \*Low Reverse Recovery(Qrr)
- \*Easy to Parallel and Simple to Drive



■ ORDER INFORMATION

Order Codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT75CL180D	TO-252	2500 pieces/Reel

■ ABSOLUTE MAXIMUM RATINGS(T<sub>c</sub> =25°C,unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V <sub>DSS</sub>	750	V
Gate-Source Voltage	V <sub>GSS</sub>	-10/+22	V
Recommended Operation Voltage Of Gate to Source	V <sub>GSOP</sub>	0/+18	V
Drain Current Continuous(T <sub>c</sub> =25°C )	I <sub>D</sub>	15.5	A
Drain Current Continuous(T <sub>c</sub> =175 °C )	I <sub>D</sub>	11	A
Drain Current Pulsed(T <sub>c</sub> =25°C )	I <sub>DM</sub>	25	A
Power Dissipation	P <sub>D</sub>	67	W
Junction Temperature	T <sub>J</sub>	+175	°C
Storage Temperature	T <sub>STG</sub>	-55~ +175	°C

■ THERMAL CHARACTERISTICS

Parameter	Symbol	Typ	Unit
Junction to Case	R <sub>thJC</sub>	2.23	°C/W

■ ELECTRICAL CHARACTERISTICS ( $T_C=25^{\circ}\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain to Source Breakdown Voltage	$V_{DSS}$	$V_{GS}=0V, I_D=500\mu A$	750	-	-	V
Drain to Source Leakage Current	$I_{DSS}$	$V_{DS}=750V, V_{GS}=0V$	-	-	10	$\mu A$
Gate to Source Forward Leakage	$I_{GSS}$	$V_{DS}=0V, V_{GS}=18V$	-	-	250	nA
On characteristics						
Drain to Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=15V, I_D=5A$	-	220	250	$m\Omega$
		$V_{GS}=18V, I_D=5A$	-	150	180	$m\Omega$
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	2.5	4	V
Dynamic characteristics						
Gate capacitance	$R_g$	$V_{AC}=25mV, f=1.0MHz$	-	25.5	-	$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=40V, V_{GS}=0V$ $f=1.0MHz$	-	308	-	pF
Output Capacitance	$C_{oss}$		-	63	-	pF
Reverse Transfer Capacitance	$C_{rss}$		-	1	-	pF
Resistive Switching Characteristics						
Turn-on Delay Time	$t_{d(ON)}$	$I_D=5A, V_{DS}=400V$ $R_G=4.3\Omega, V_{GS}=0/15V$	-	6.6	-	ns
Rise Time	$t_r$		-	18.3	-	ns
Turn-off Delay Time	$t_{d(OFF)}$		-	17.7	-	ns
Fall Time	$t_f$		-	32.1	-	ns
Total Gate Charge	$Q_g$	$I_D=5A, V_{DS}=400V$ $V_{GS}=0/15V$	-	12.5	-	nC
Gate to Source Charge	$Q_{gs}$		-	4.3	-	nC
Gate to Drain("Miller") Charge	$Q_{gd}$		-	1.6	-	nC
Source-Drain Diode Characteristics						
Continuous Source Current(Body Diode)	$I_S$		-	-	15.5	A
Diode Forward Voltage	$V_{SD}$	$I_{SD}=2.5A, V_{GS}=0V$	-	3.3	-	V
Reverse Recovery Time	$t_{rr}$	$I_{SD}=5A, T_J=25^{\circ}\text{C}$ $di/dt=1600A/\mu s$	-	32.6	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	9.9	-	nC

■ TYPICAL CHARACTERISTICS

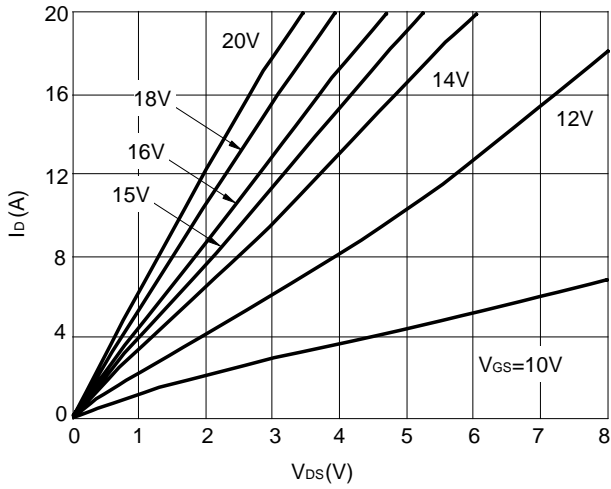


Figure 1: Output Characteristics( $T_J=25^\circ\text{C}$ )

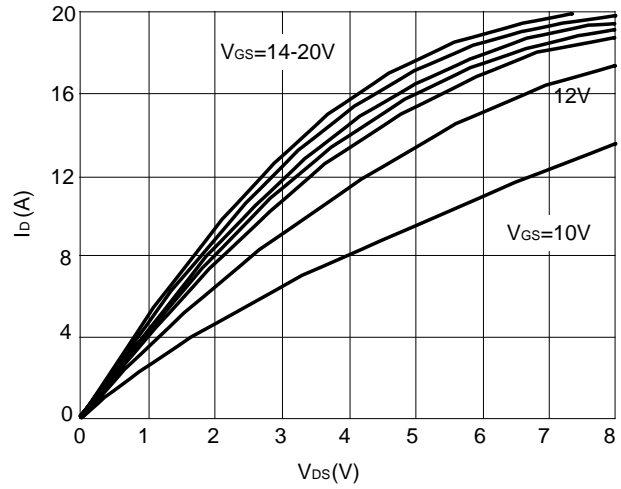


Figure 1: Output Characteristics( $T_J=25^\circ\text{C}$ )

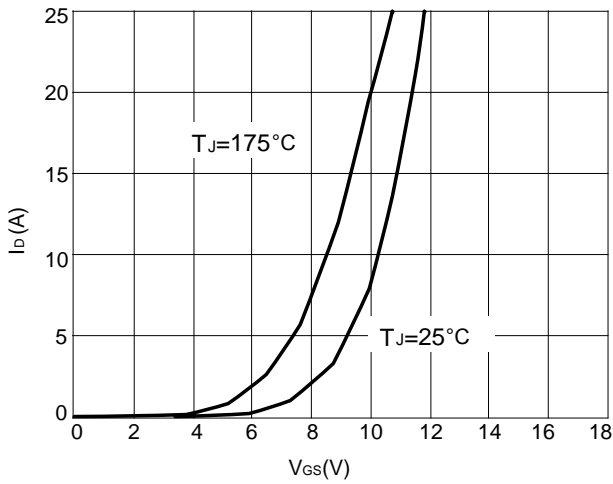


Figure 3: Typical Transfer Characteristics

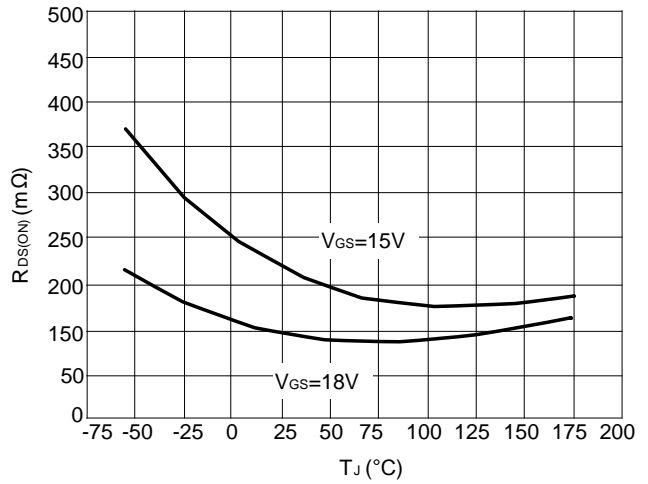


Figure 4: Typical On-Resistance vs Temperature

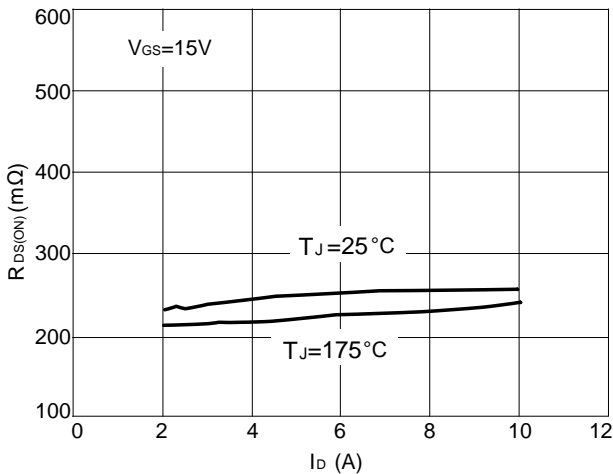


Figure 5: Normalized On-Resistance vs. Drain Current For Various Temperature

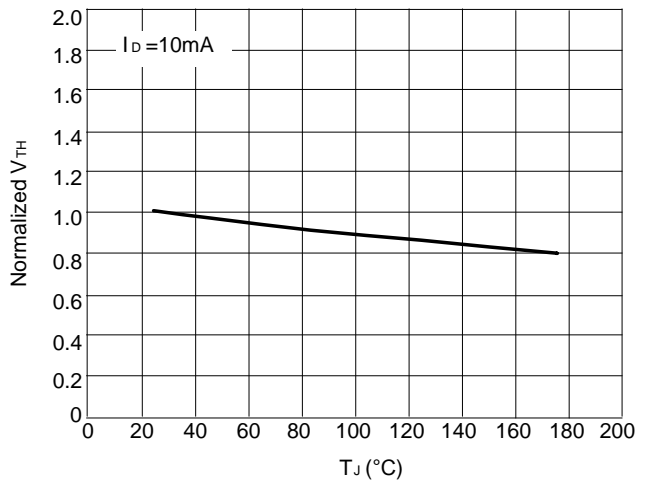


Figure 6: Normalized Threshold Voltage vs. Temperature

■ TYPICAL CHARACTERISTICS(Cont.)

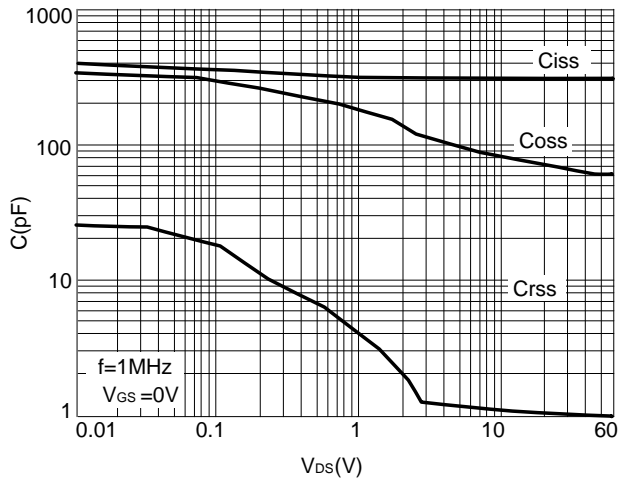


Figure 7: Capacitance vs. Drain-Source Voltage

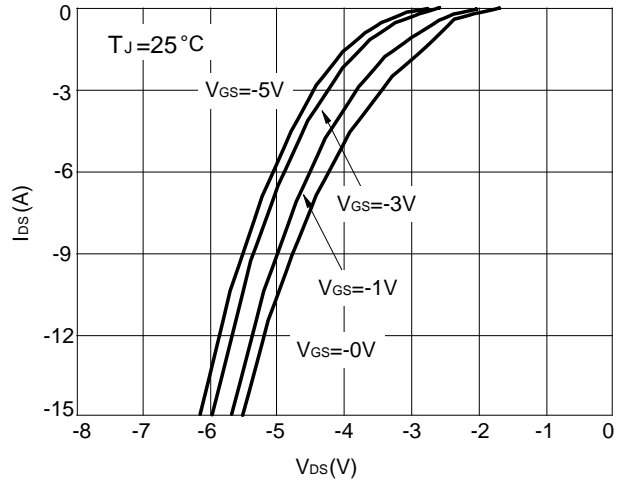


Figure 8: Body Diode Characteristics

■ TO-252 PACKAGE OUTLINE DIMENSIONS

